

Think Think

CMOS linear image sensors

S15908-512Q S15909-1024Q

Smooth spectral sensitivity in UV to NIR regions, With variable integration time function for each pixel

The S15908-512Q and S15909-1024Q are self-scanning photodiode arrays designed specifically as detectors for spectroscopy. The scanning circuit operates at low power consumption and is easy to handle. Each photodiode has a large photosensitive area and smoothly varying spectral response characteristics in UV to near IR region.

Features

- Suppress fringe of spectral response curve from UV to IR region
- → High UV sensitivity: 0.09 A/W (λ=250 nm)
- Low dark current: 0.03 pA
- → Large saturation output charge: 200 pC (S15908-512Q)

100 pC (S15909-1024Q)

■ Variable integration time for each pixel

Applications

Spectrophotometry

Structure

Type no.	Number of pixels	Pixel pitch (µm)	Pixel height (mm)	Package	Window material *1 *2	Weight (g)
S15908-512Q	512	50	2.5	Corpmia	Ougeta	2.5
S15909-1024Q	1024	25	2.5	Ceramic	Quartz	3.5

^{*1:} Resin sealing

- Absolute maximum ratings

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply voltage	Vdd	Ta=25 °C	-0.3	-	+6	V
Clock pulse voltage	V(CLK)	Ta=25 °C	-0.3	-	+6	V
Start pulse voltage	V(ST)	Ta=25 °C	-0.3	-	+6	V
Integration time control pulse	V(INT)	Ta=25 °C	-0.3	-	+6	V
Overflow gate voltage	Vofg	Ta=25 °C	-0.3	-	+6	V
Overflow drain voltage	Vofd	Ta=25 °C	-0.3	-	+6	V
Operating temperature	Topr	No dew condensation*3	-5	-	+65	°C
Storage temperature	Tstg	No dew condensation*3	-10	-	+85	°C

^{*3:} When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

^{*2:} Refractive index=1.46

■ Recommended terminal voltage (Ta=25 °C)

Parameter		Symbol	Min.	Тур.	Max.	Unit	
Supply voltage		Vdd	4.75	5	5.25	V	
Clock pulse veltage	High level	///CLK)	Vdd - 0.25	Vdd	Vdd + 0.25	V	
Clock pulse voltage	Low level	V(CLK)	0	-	0.4		
Start pulse voltage	High level	V(ST)	Vdd - 0.25	Vdd	Vdd + 0.25	W	
	Low level		0	-	0.4	'	
Integration time	High level	\//TNIT\	Vdd - 0.25	Vdd	Vdd + 0.25	V	
control pulse voltage Low level		V(INT)	0	-	0.4	\ \ \	
Overflow drain voltage		Vofd	0.5	2	2.5	V	
Overflow gate voltage		Vofg	0.17	0.2	0.23	V	

■ Electrical characteristics [Ta=25 °C, Vdd=5 V, Vb=Vofd=2 V, Vofg=0.2 V]

Parameter	Symbol	Min.	Тур.	Max.	Unit
Clock pulse frequency	f(CLK)	10 k	-	250 k	Hz
Data rate	DR	-	f(CLK)	-	Hz
Power consumption*4 S15908-512Q S15909-10240	n	-	4.25	-	mW
S15909-1024Q] r	-	8.25	-	IIIVV
Video line capacitance S15908-512Q	Cv	-	22	-	nΕ
(Vb=2 V)*5 S15909-1024Q	CV	-	32	-	pF

^{*4:} f(CLK)=250 kHz

■ Electrical and optical characteristics [Ta=25 °C, Vdd=5 V, Vb=Vofd=2 V, Vofg=0.2 V, f(CLK)=200 kHz]

Parameter		Symbol	Min.	Тур.	Max.	Unit
Spectral response range		λ		200 to 1000		nm
Peak sensitivity way	Peak sensitivity wavelength λp		-	750	-	nm
Dark current		ID	-	0.03	0.3	pА
Saturation output	S15908-512Q	Ocat	150	200	-	nC
charge	S15909-1024Q	Qsat	75	100	-	pC
Saturation exposure*6		Esat	-	700	-	$mlx \cdot s$
Photo response non-uniformity*6 *7 *8		PRNU	-	-	±3	%

^{*6:} Measured with a tungsten lamp of 2856 K



^{*5:} Vb is the voltage at the non-inverting input terminal of the charge amplifier in the current-integration readout circuit. [See the readout circuit example (p.8).]

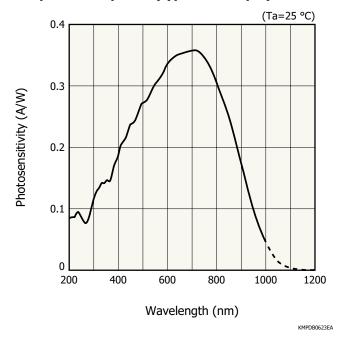
^{*7:} Photo response non-uniformity is defined under the condition that the device is uniformly illuminated by light which is 50 % of the saturation exposure level as follows:

PRNU= $\Delta X/X \times 100$ (%)

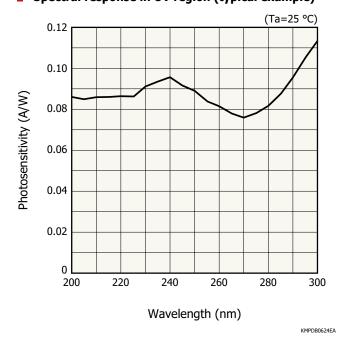
X: the average output of all pixels, ΔX : difference between X and maximum or minimum output.

^{*8:} Except for the first and last pixels

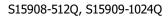
Spectral response (typical example)

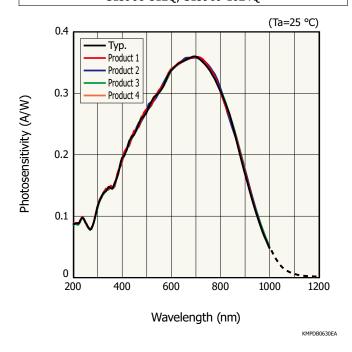


- Spectral response in UV region (typical example)



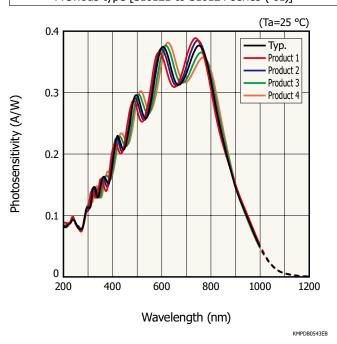
Photosensitivity variations (typical example)



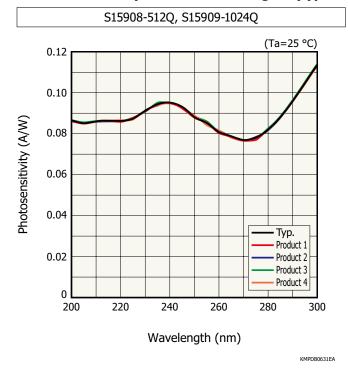


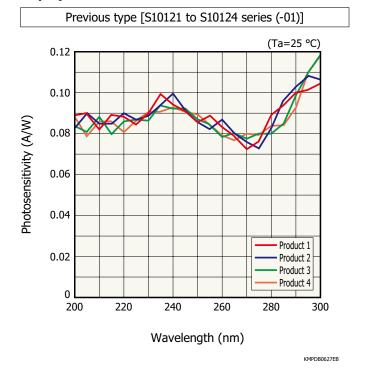
Compared to previous products, smooth spectral sensitivity from UV to near IR region is realized and photosensitivity variations is suppressed.

Previous type [S10121 to S10124 series (-01)]

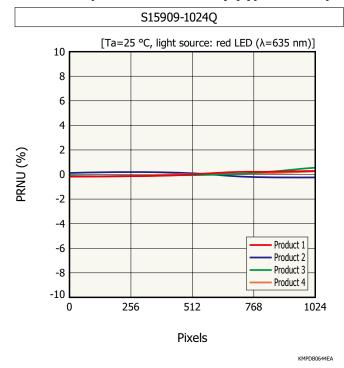


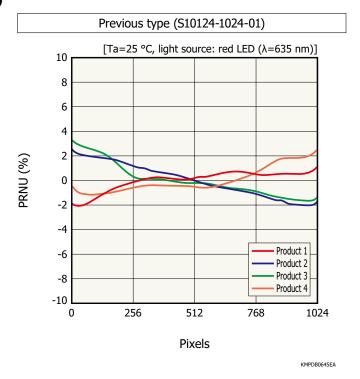
Photosensitivity variation in UV region (typical example)





Photoresponse nonuniformity (typical example)





Compared to previous types, PRNU has been reduced.

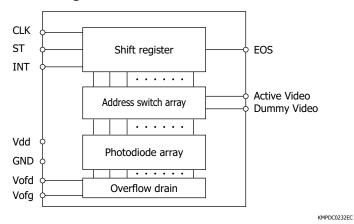
Photo response non-uniformity is defined under the condition that the device is uniformly illuminated by light which is 50 % of the saturation exposure level as follows:

PRNU= $\Delta X/X \times 100$ (%)

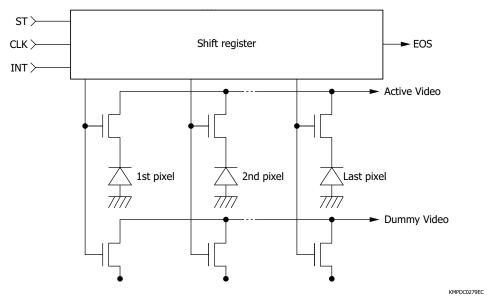
X: the average output of all pixels,

 ΔX : difference between X and maximum or minimum output.

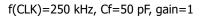
Block diagram

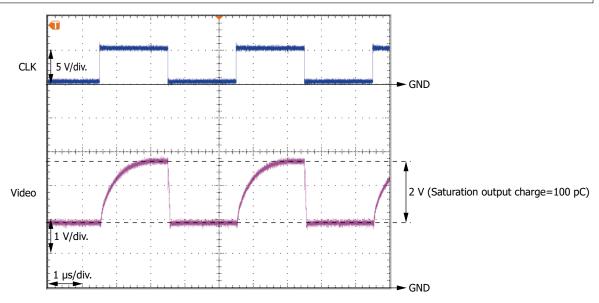


Equivalent circuit

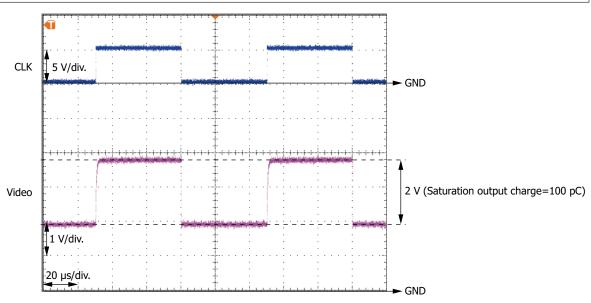


Output waveform of one pixel (S15909-1024Q)

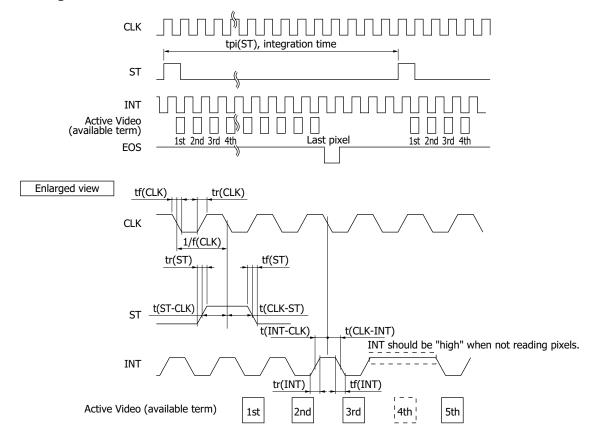




f(CLK)=10 kHz, Cf=50 pF, gain=1



- Timing chart



Note: \cdot Allow CLK pulse transition from "high" to "low" only one time while ST pulse is "high".

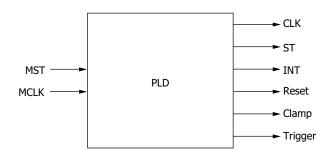
- · Integration time is determined by the interval between start pulses.
- \cdot Only the switching noise component is output from the Dummy Video.
- · Do not use the Dummy Video output during current-integration readout.
- · The INT signal is not needed between EOS and the rising edge of the next ST signal.

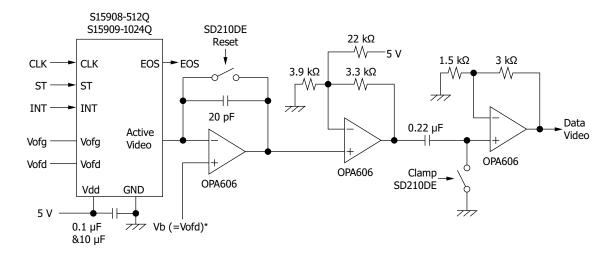
KMPDC0249ED

Parameter		Symbol	Min.	Тур.	Max.	Unit
Start pulse (ST)	S15908-512Q	tni/CT)	514/f(CLK)	-	-	
cycle	S15909-1024Q	ψ(31)	tpi(ST) 1026/f(CLK)	-	-	5
INT pulse rise and	d fall times	tr(INT), tf(INT)	0	20	30	ns
INT pulse - clock pulse timing		t(INT-CLK)	30	-	1 / [2 × f(CLK)]	ns
Clock pulse - INT pulse timing		t(CLK-INT)	30	-	1 / [2 × f(CLK)]	ns
Start pulse rise and fall times		tr(ST), tf(ST)	0	20	30	ns
Clock pulse duty ratio		-	40	50	60	%
Clock pulse rise and fall times		tr(CLK), tf(CLK)	0	20	30	ns
Clock pulse - start pulse timing		t(CLK-ST)	20	-	-	ns
Start pulse - clock pulse timing		T(ST-CLK)	20	-	-	ns

Current-integration readout circuit example and timing chart example

■ Readout circuit example

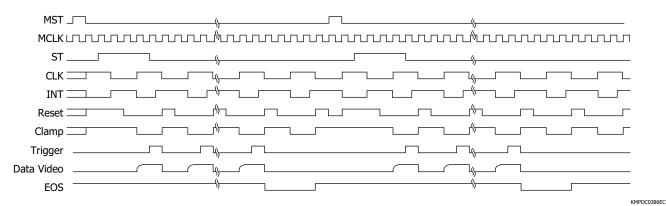




 $^{^{\}star}$ Supply the Vb terminal with the same voltage as Vofd.

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■ Timing chart example

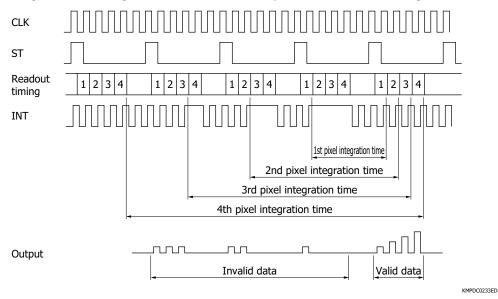


Variable integration time function for each pixel

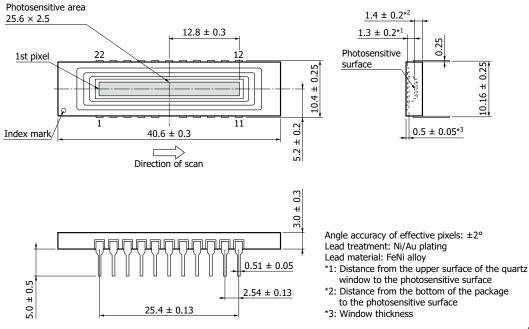
By controlling the clock pulse to the INT terminal, the integration time for each pixel can be changed to any length that is an integer multiple of one readout period. When the clock pulse at the INT terminal is set to "high" at certain pixels signal readout timing, no signal is output from that pixel (see below). This allows the signal charge to continuously accumulate in that pixel as long as no signal is output. For example, when the integration time of one readout period is 100 ms and this function is used to output a signal from a pixel once every 3 readout periods, then the integration time of that pixel will be 300 ms. Using this function to lengthen the integration time of certain pixels makes it possible to effectively detect spectral signals of weak wavelength components.

■ Timing chart

(Concept view showing the settings to double, triple and quadruple the integration times at 2nd, 3rd and 4th pixels, respectively, by using the variable integration time function for each pixel on the basis of the integration time at 1st pixel.)

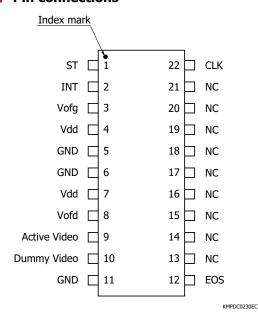


Dimensional outlines (unit: mm)



KMPDA0062EH

Pin connections



Pin no.	Symbol	Name of pin	I/O
1	ST	Start pulse	I
2	INT	Integration time control pulse	I
3	Vofg	Overflow gate voltage	I
4	Vdd	Supply voltage	I
5	GND	Ground	I
6	GND	Ground	I
7	Vdd	Supply voltage	I
8	Vofd	Overflow drain voltage	I
9	Active Video	Video output	0
10	Dummy Video	Dummy video output	0
11	GND	Ground	I
12	EOS	End of scan	0
13	NC		
14	NC		
15	NC		
16	NC		
17	NC	No connection	
18	NC		
19	NC		
20	NC		
21	NC		
22	CLK	Clock pulse	I

Recommended soldering conditions

Parameter	Specification	Note
Soldering temperature	260 °C max. (5 s or less)	

Note: When you set soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

Precautions

(1) Electrostatic countermeasures

These devices have a built-in protection circuit against static electrical charges. However, to prevent destroying the device with electrostatic charges, take countermeasures such as grounding yourself, the workbench and tools to prevent static discharges. Also protect these devices from surge voltages which might be caused by peripheral equipment.

(2) Incident window

If dust or dirt gets on the light incident window, it will show up as black blemishes on the image. When cleaning, avoid rubbing the window surface with dry cloth or dry cotton swab, since doing so may generate static electricity. Use soft cloth, paper or a cotton swab moistened with alcohol to wipe dust and dirt off the window surface. Then blow compressed air onto the window surface so that no spot or stain remains.

(3) UV exposure

These devices are designed to suppress performance deterioration due to UV exposure. Even so, avoid unnecessary UV exposure to the device. Also, be careful not to allow UV light to strike the cemented portion of the glass.

CMOS linear image sensors

S15908-512Q, S15909-1024Q

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- · Image sensors

Driver circuit for CMOS linear image sensors (sold separately)

Please contact us for detailed information.

Information described in this material is current as of June 2024.

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